

A

B

C

D

E

## ASSEMBLY NOTES:

Assembly shall conform to IPC-A-610 Class 2.

Assembly shall conform with RoHS Directive 2011/65/EU.

Components shall be placed according to the associated CPL and BOM documents.

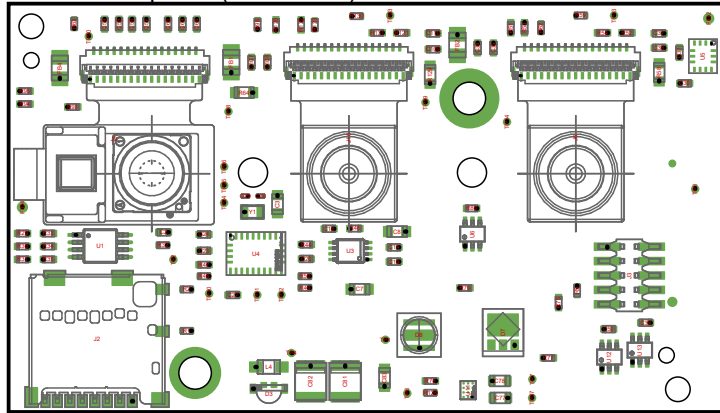
Lead-free SAC305 solder shall be used.

Reflow profile shall comply with J-STD-20C Lead-Free Reflow Profile.

BGA components shall be 100% checked with x-ray for solder bridges after reflow.

Finished assemblies shall be removed from panel prior to delivery.

View from Top side (Scale 1.5:1)

Title: **EL2086**Number: D2088000 Revision: R0M0  
E0

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Drawn by: Eason Lin

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A

B

C

D

E



A

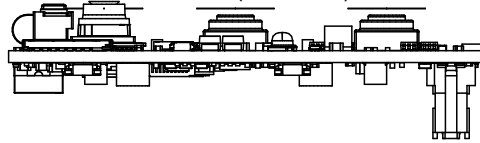
B

C

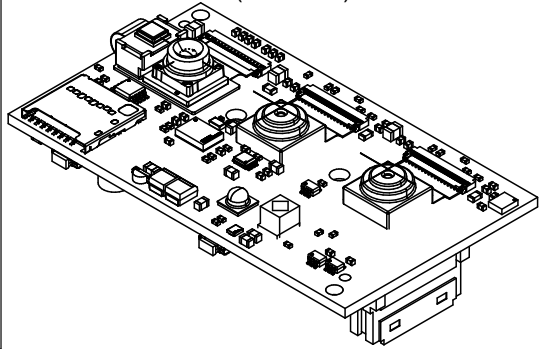
D

E

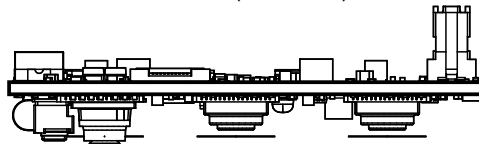
View from Front side (Scale 1:1)



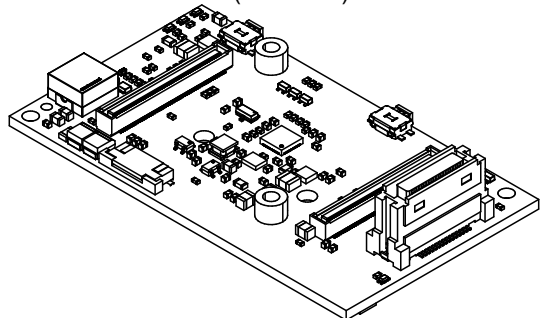
View from Front side (Scale 1:1)



View from Back side (Scale 1:1)



View from Back side (Scale 1:1)

Title: **EL2086**Number: D2088000 Revision: R0M0  
E0

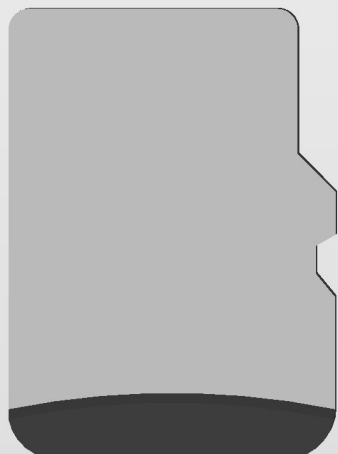
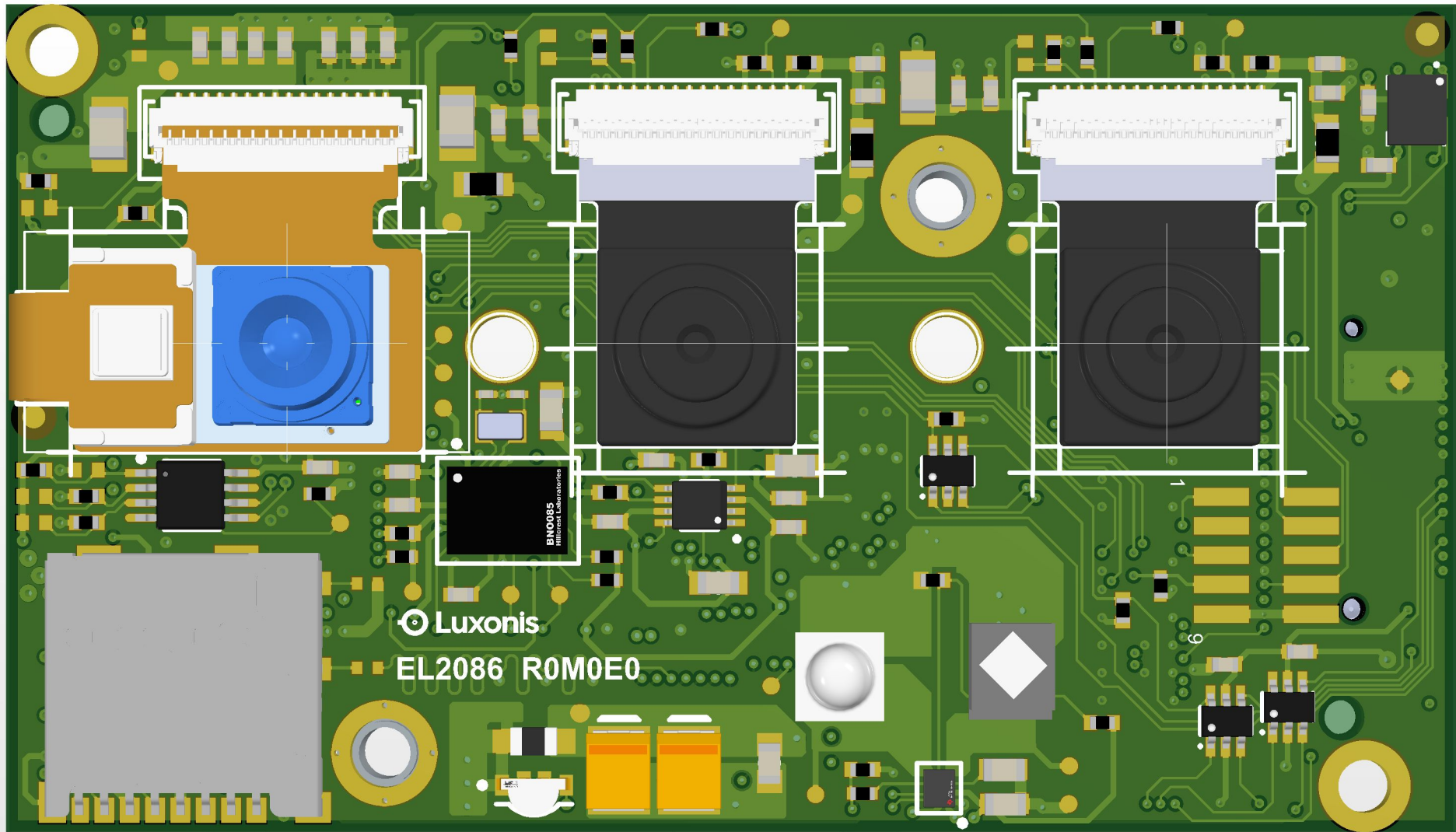
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BOURNS

